

- Features**
- 3.2 x 1.6 mm (1206) footprint
 - High intensity
 - Wide viewing angle
 - Flat water clear epoxy lens
 - Suitable for reflow soldering
 - Supplied on 178 mm dia reel
 - Quantity per reel 3000 pieces



Electro / Optical Characteristics $I_F = 20 \text{ mA}$ $T_a = 25^\circ$

Part Number	Emitting Colour	Epoxy Type	Die Material	Wavelength		Forward Voltage V_F		Luminous intensity I_V		Viewing \angle 20½
				Peak λ_p	Dominant λ_d	typical	max	min	typical	
FA-150DLG	Green	WC	InGaN	523	525	3.50	4.20	-	110	140
FA-150DBG	Blue green	WC	InGaN	500	505	3.50	4.20	-	110	140
FA-150DNB	Blue	WC	InGaN	468	470	3.50	4.20	-	40	140
FA-150CB	Blue	WC	InGaN	468	470	3.50	4.20	-	30	140
FA-150SB	Blue	WC	GaN	428	466	3.80	4.50	-	18	140
Units				nm		V		mcd		deg

Maximum Ratings $T_a = 25^\circ \text{ C}$ (Derate above 25° C)

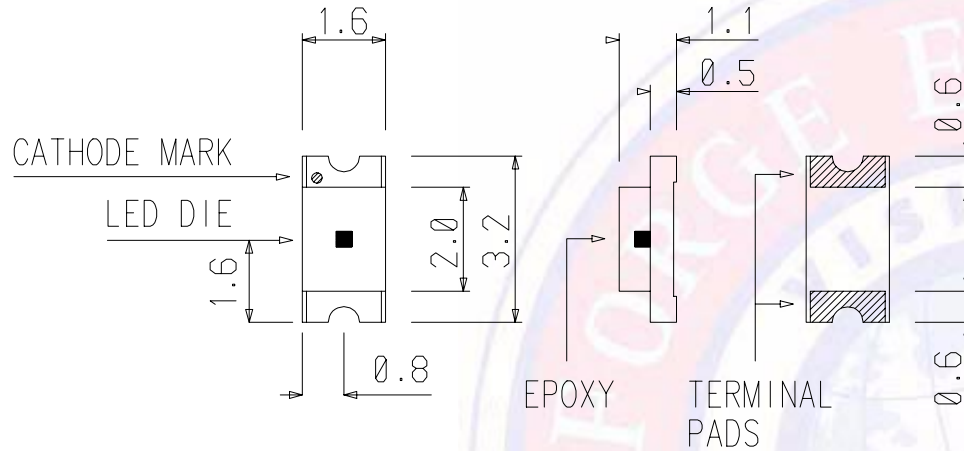
Characteristic	Condition	Symbol	Rating	Units	
Pulse Forward Current	0.1 duty cycle 0.1 ms pulse width	Normal	I_{FP}	100	mA
		SB	I_{FP}	70	mA
DC Forward Current	Normal	I_F	20	mA	
	SB	I_F	15	mA	
Reverse Voltage	$I_R = 10 \mu\text{A}$	V_R	5	V	
Power Dissipation	Normal	P_D	84	mW	
	SB	P_D	68	mW	
Operating Temperature		T_{opr}	- 30 to + 80	$^\circ \text{C}$	
Storage Temperature		T_{stg}	- 40 to + 85	$^\circ \text{C}$	

Note

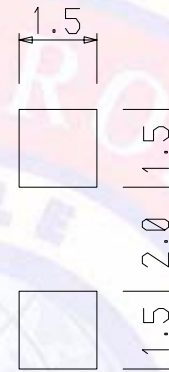
Industry standard procedures regarding static must be observed when handling product produced with the following die materials.

InGaN
GaN

Package Outline

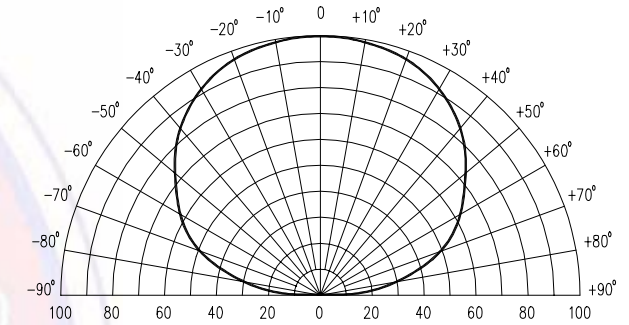


Solder Pad Pattern

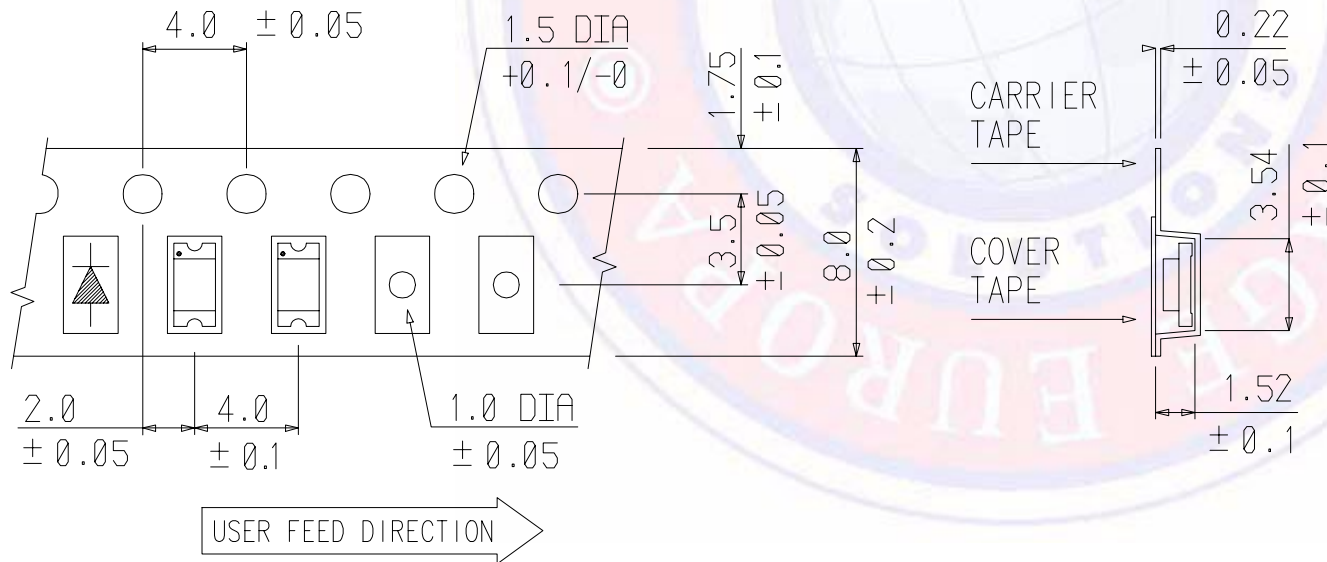


Radiation Diagram

$T_a = 25^\circ\text{C}$ $I_F = 20\text{ mA}$



Relative angular intensity



Tape Dimensions

Dimensions in mm
Tolerance $\pm 0.1\text{ mm}$ unless stated